# 5.0 V, 750 mA Low Dropout Linear Regulator with Delayed RESET

The CS8126 is a low dropout, high current 5.0 V linear regulator. It is an improved replacement for the CS8156. Improvements include higher accuracy, tighter saturation control, better supply rejection, and enhanced RESET circuitry. Familiar PNP regulator features such as reverse battery protection, overvoltage shutdown, thermal shutdown, and current limit make the CS8126 suitable for use in automotive and battery operated equipment. Additional on–chip filtering has been included to enhance rejection of high frequency transients on all external leads.

An active microprocessor RESET function is included on—chip with externally programmable delay time. During power—up, or after detection of any error in the regulated output, the RESET lead will remain in the low state for the duration of the delay. Types of errors include short circuit, low input voltage, overvoltage shutdown, thermal shutdown, or others that cause the output to become unregulated. This function is independent of the input voltage and will function correctly with an output voltage as low as 1.0 V. Hysteresis is included in both the reset and Delay comparators for enhanced noise immunity. A latching discharge circuit is used to discharge the Delay capacitor, even when triggered by a relatively short fault condition. This circuit improves upon the commonly used SCR structure by providing full capacitor discharge (0.2 V type).

Note: The CS8126 is lead compatible with the LM2927 and LM2926.

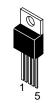
#### **Features**

- Low Dropout Voltage (0.6 V at 0.5 A)
- 3.0% Output Accuracy
- Active RESET
- External RESET Delay for Reset
- Protection Circuitry
  - Reverse Battery Protection
  - +60 V, -50 V Peak Transient Voltage
  - Short Circuit Protection
  - Internal Thermal Overload Protection
- Pb-Free Packages are Available



# ON Semiconductor®

http://onsemi.com



TO-220-5 T SUFFIX CASE 314D



TO-220-5 TVA SUFFIX CASE 314K

Pin 1. V<sub>IN</sub> 2. V<sub>OUT</sub>







TO-220-5 THA SUFFIX CASE 314A



TO-220-5 THE SUFFIX CASE 314J



D<sup>2</sup>PAK-7 DPS SUFFIX CASE 936AB

Pin 1. V<sub>IN</sub>

- 2. V<sub>OUT</sub>
- 3. V<sub>OUT(SENSE)</sub>
- 4. GND
- 5. Delay
- 6. RESET
- 7. NC

#### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 9 of this data sheet.

#### **DEVICE MARKING INFORMATION**

See general marking information in the device marking section on page 9 of this data sheet.

\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

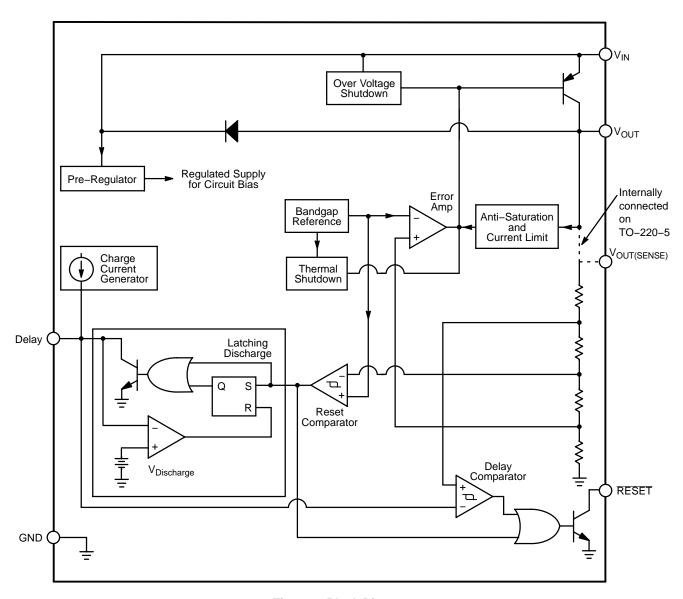


Figure 1. Block Diagram

#### **MAXIMUM RATINGS\***

Rating		Value	Unit
Power Dissipation		Internally Limited	-
Peak Transient Voltage (46 V Load Dump)		-50, 60	V
Output Current		Internally Limited	-
ESD Susceptibility (Human Body Model)		4.0	kV
Package Thermal Resistance, TO-220-5: Junction-to-Case, $R_{\theta JC}$ Junction-to-Ambient, $R_{\theta JA}$		2.1 50	°C/W °C/W
Package Thermal Resistance, D <sup>2</sup> PAK–7: Junction–to–Case, $R_{\theta JC}$ Junction–to–Ambient, $R_{\theta JA}$		2.1 10–50**	°C/W
Junction Temperature Range		-40 to +150	°C
Storage Temperature Range		-55 to +150	°C
Lead Temperature Soldering:	Wave Solder (through hole styles only) (Note 1) Reflow (SMD styles only) (Note 2)	260 peak 230 peak	°C °C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

# **ELECTRICAL CHARACTERISTICS** ( $T_A = -40^{\circ}C$ to +125°C, $T_J = -40^{\circ}C$ to +150°C, $V_{IN} = 6.0$ to 26 V, $I_O = 5.0$ to 500 mA, $R_{RESET} = 4.7$ k $\Omega$ to $V_{CC}$ , unless otherwise noted.)

Characteristic	Test Conditions	Min	Тур	Max	Unit
Output Stage (V <sub>OUT</sub> )					
Output Voltage	-	4.85	5.00	5.15	V
Dropout Voltage	I <sub>OUT1</sub> = 500 mA	_	0.35	0.60	V
Supply Current	$I_{OUT} \le 10 \text{ mA}$ $I_{OUT} \le 100 \text{ mA}$ $I_{OUT} \le 500 \text{ mA}$	- - -	2.0 6.0 55	7.0 12 100	mA mA mA
Line Regulation	V <sub>IN</sub> = 6.0 to 26 V, I <sub>OUT</sub> = 50 mA	-	5.0	50	mV
Load Regulation	I <sub>OUT</sub> = 50 to 500 mA, V <sub>IN</sub> = 14 V	_	10	50	mV
Ripple Rejection	f = 120 Hz, V <sub>IN</sub> = 7.0 to 17 V, I <sub>OUT</sub> = 250 mA	54	75	_	dB
Current Limit	-	0.75	1.20	_	Α
Overvoltage Shutdown	-	32	_	40	V
Maximum Line Transient	V <sub>OUT</sub> ≤ 5.5 V	-	95	_	V
Reverse Polarity Input Voltage DC	V <sub>OUT</sub> ≥ −0.6 V, 10 Ω Load	-15	-30	_	V
Reverse Polarity Input Voltage Transient	1.0% Duty Cycle, T < 100 ms, 10 Ω Load	_	-80	_	V
Thermal Shutdown	Note 3	150	180	210	°C

3. Guaranteed By Design

<sup>1. 10</sup> second maximum.

<sup>2. 60</sup> second maximum above 183°C.

<sup>\*</sup>The maximum package power dissipation must be observed.

<sup>\*\*</sup>Depending on thermal properties of substrate.  $R_{\theta JA} = R_{\theta JC} + R_{\theta CA}$ .

**ELECTRICAL CHARACTERISTICS (continued)** ( $T_A = -40^{\circ}C$  to +125°C,  $T_J = -40^{\circ}C$  to +150°C,  $V_{IN} = 6.0$  to 26 V,  $I_O = 5.0$  to 500 mA,  $R_{RESET} = 4.7$  k $\Omega$  to  $V_{CC}$ , unless otherwise noted.)

Characteristic	Test Conditions	Min	Тур	Max	Unit		
RESET and Delay Functions	RESET and Delay Functions						
Delay Charge Current	V <sub>Delay</sub> = 2.0 V	5.0	10	15	μΑ		
RESET Threshold	V <sub>OUT</sub> Increasing, V <sub>RT(ON)</sub> V <sub>OUT</sub> Decreasing, V <sub>RT(OFF)</sub>	4.65 4.50	4.90 4.70	V <sub>OUT</sub> - 0.01 V <sub>OUT</sub> - 0.15	V V		
RESET Hysteresis	$V_{RH} = V_{RT(ON)} - V_{RT(OFF)}$	150	200	250	mV		
Delay Threshold	Charge, V <sub>DC(HI)</sub> Discharge, V <sub>DC(LO)</sub>	3.25 2.85	3.50 3.10	3.75 3.35	< <		
Delay Hysteresis	-	200	400	800	mV		
RESET Output Voltage Low	1.0 V < $V_{OUT}$ < $V_{RTL}$ , 3.0 kΩ to $V_{OUT}$	_	0.1	0.4	V		
RESET Output Leakage Current	V <sub>OUT</sub> > V <sub>RT(ON)</sub>	-	0	10	μΑ		
Delay Capacitor Discharge Voltage	Discharge Latched "ON", V <sub>OUT</sub> > V <sub>RT</sub>	-	0.2	0.5	V		
Delay Time	C <sub>Delay</sub> = 0.1 μF*. Note 4	16	32	48	ms		

<sup>\*</sup> Delay Time =  $\frac{C_{Delay} \times V_{Delay} Threshold Charge}{I_{Charge}} = C_{Delay} \times 3.2$ 

# **PACKAGE LEAD DESCRIPTION**

PACKAGI	E LEAD#		
TO-220-5 D <sup>2</sup> PAK-7 LEAD		LEAD SYMBOL	FUNCTION
1	1	V <sub>IN</sub>	Unregulated supply voltage to IC.
2	2	V <sub>OUT</sub>	Regulated 5.0 V output.
3	4	GND	Ground connection.
4	5	Delay	Timing capacitor for RESET function.
5	6	RESET	CMOS/TTL compatible output lead. RESET goes low after detection of any error in the regulated output or during power up.
_	3	V <sub>OUT</sub> (SENSE)	Remote sensing of output voltage.
_	7	NC	No Connection.

<sup>4.</sup> Assumes Ideal Capacitor

#### TYPICAL PERFORMANCE CHARACTERISTICS

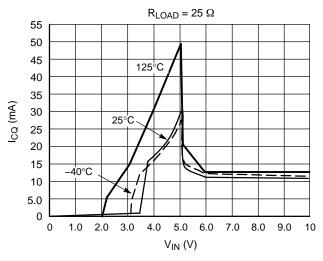


Figure 2. I<sub>CQ</sub> vs. V<sub>IN</sub> Over Temperature

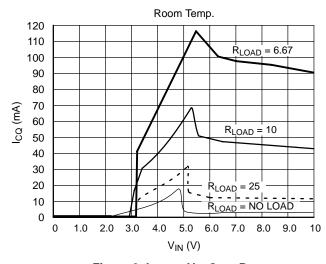


Figure 3.  $I_{CQ}$  vs.  $V_{IN}$  Over  $R_{LOAD}$ 

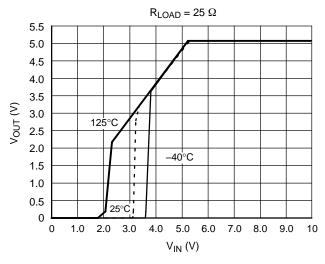


Figure 4. V<sub>OUT</sub> vs. V<sub>IN</sub> Over Temperature

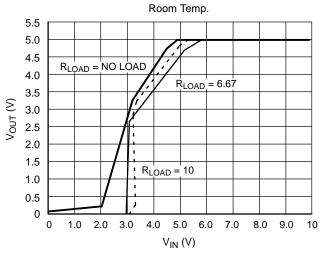


Figure 5. V<sub>OUT</sub> vs. V<sub>IN</sub> Over R<sub>LOAD</sub>

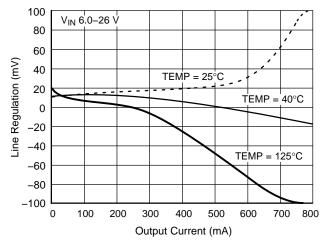


Figure 6. Line Regulation vs. Output Current Over Temperature

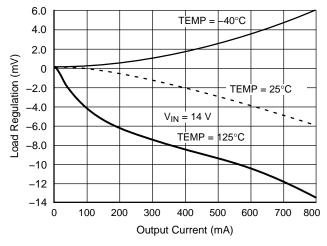


Figure 7. Load Regulation vs. Output Current Over Temperature

# TYPICAL PERFORMANCE CHARACTERISTICS (continued)

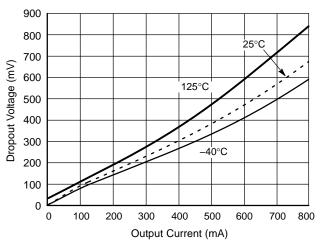


Figure 8. Dropout Voltage vs. Output Current Over Temperature

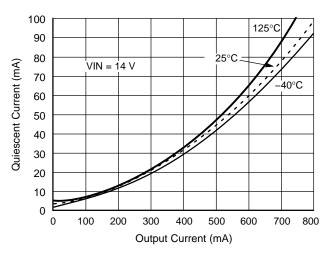


Figure 9. Quiescent Current vs. Output
Current Over Temperature

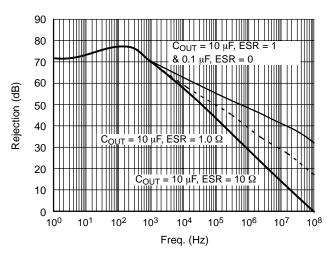


Figure 10. Ripple Rejection

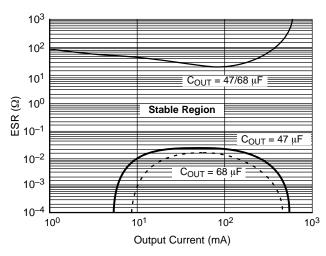


Figure 11. Output Capacitor ESR

#### RESET CIRCUIT WAVEFORM

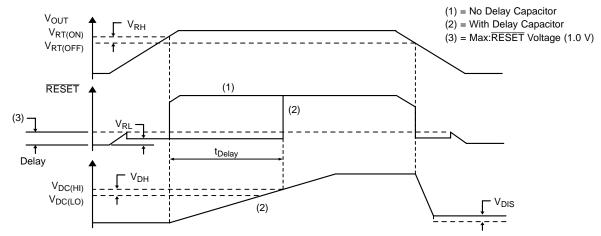


Figure 12. RESET Circuit Waveform

#### CIRCUIT DESCRIPTION

The CS8126 RESET function, has hysteresis on both the Reset and Delay comparators, a latching Delay capacitor discharge circuit, and operates down to 1.0 V.

The RESET circuit output is an open collector type with ON and OFF parameters as specified. The RESET output NPN transistor is controlled by the two circuits described (see Block Diagram).

### Low Voltage Inhibit Circuit

This circuit monitors output voltage, and when the output voltage falls below  $V_{RT(OFF)}$ , causes the  $\overline{RESET}$  output transistor to be in the ON (saturation) state. When the output voltage rises above  $V_{RT(ON)}$ , this circuit permits the  $\overline{RESET}$  output transistor to go into the OFF state if allowed by the  $\overline{RESET}$  Delay circuit.

# **RESET** Delay Circuit

This circuit provides a programmable (by external capacitor) delay on the RESET output lead. The Delay lead provides source current to the external delay capacitor only when the "Low Voltage Inhibit" circuit indicates that output

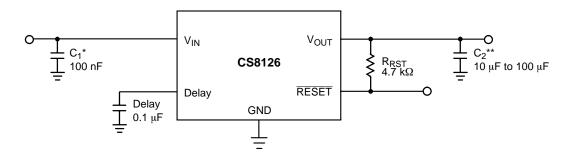
voltage is above  $V_{RT(ON)}$ . Otherwise, the Delay lead sinks current to ground (used to discharge the delay capacitor). The discharge current is latched ON when the output voltage falls below  $V_{RT(OFF)}$ . The Delay capacitor is fully discharged anytime the output voltage falls out of regulation, even for a short period of time. This feature ensures a controlled  $\overline{RESET}$  pulse is generated following detection of an error condition. The circuit allows the  $\overline{RESET}$  output transistor to go to the OFF (open) state only when the voltage on the Delay lead is higher than  $V_{DC(H1)}$ .

The Delay time for the  $\overline{RESET}$  function is calculated from the formula:

$$\mbox{Delay time} = \frac{\mbox{C}_{\mbox{Delay}} \times \mbox{V}_{\mbox{Delay}}\mbox{Threshold}}{\mbox{I}_{\mbox{Charge}}}$$

Delay time = 
$$C_{Delay} \times 3.2 \times 10^5$$

If  $C_{Delay} = 0.1 \,\mu\text{F}$ , Delay time (ms) = 32 ms  $\pm$  50%: i.e. 16 ms to 48 ms. The tolerance of the capacitor must be taken into account to calculate the total variation in the delay time.



- $^{\star}$  C<sub>1</sub> is required if the regulator is far from the power source filter.
- \*\* C<sub>2</sub> is required for stability.

Figure 13. Application Diagram

#### **APPLICATION NOTES**

#### **Stability Considerations**

The output or compensation capacitor helps determine three main characteristics of a linear regulator: start-up delay, load transient response and loop stability.

The capacitor value and type should be based on cost, availability, size and temperature constraints. A tantalum or aluminum electrolytic capacitor is best, since a film or ceramic capacitor with almost zero ESR, can cause instability. The aluminum electrolytic capacitor is the least expensive solution, but, if the circuit operates at low

temperatures (-25°C to -40°C), both the value and ESR of the capacitor will vary considerably. The capacitor manufacturers data sheet usually provides this information.

The value for the output capacitor  $C_2$  shown in the test and applications circuit should work for most applications, however it is not necessarily the optimized solution.

To determine an acceptable value for  $C_2$  for a particular application, start with a tantalum capacitor of the recommended value and work towards a less expensive alternative part.

**Step 1:** Place the completed circuit with a tantalum capacitor of the recommended value in an environmental chamber at the lowest specified operating temperature and monitor the outputs with an oscilloscope. A decade box connected in series with the capacitor will simulate the higher ESR of an aluminum capacitor. Leave the decade box outside the chamber, the small resistance added by the longer leads is negligible.

**Step 2:** With the input voltage at its maximum value, increase the load current slowly from zero to full load while observing the output for any oscillations. If no oscillations are observed, the capacitor is large enough to ensure a stable design under steady state conditions.

**Step 3:** Increase the ESR of the capacitor from zero using the decade box and vary the load current until oscillations appear. Record the values of load current and ESR that cause the greatest oscillation. This represents the worst case load conditions for the regulator at low temperature.

**Step 4:** Maintain the worst case load conditions set in step 3 and vary the input voltage until the oscillations increase. This point represents the worst case input voltage conditions.

**Step 5:** If the capacitor is adequate, repeat steps 3 and 4 with the next smaller valued capacitor. A smaller capacitor will usually cost less and occupy less board space. If the output oscillates within the range of expected operating conditions, repeat steps 3 and 4 with the next larger standard capacitor value.

**Step 6:** Test the load transient response by switching in various loads at several frequencies to simulate its real working environment. Vary the ESR to reduce ringing.

**Step 7:** Raise the temperature to the highest specified operating temperature. Vary the load current as instructed in step 5 to test for any oscillations.

Once the minimum capacitor value with the maximum ESR is found, a safety factor should be added to allow for the tolerance of the capacitor and any variations in regulator performance. Most good quality aluminum electrolytic capacitors have a tolerance of  $\pm$  20% so the minimum value found should be increased by at least 50% to allow for this tolerance plus the variation which will occur at low temperatures. The ESR of the capacitor should be less than 50% of the maximum allowable ESR found in step 3 above.

# Calculating Power Dissipation in a Single Output Linear Regulator

The maximum power dissipation for a single output regulator (Figure 14) is:

$$P_{D(max)} = [V_{IN(max)} - V_{OUT(min)}]I_{OUT(max)} + V_{IN(max)}I_{Q}$$
 (1)

where:

 $V_{IN(max)}$  is the maximum input voltage,

V<sub>OUT(min)</sub> is the minimum output voltage,

 $I_{OUT(max)}$  is the maximum output current, for the application, and

 $I_Q$  is the quiescent current the regulator consumes at  $I_{OUT(max)}$ .

Once the value of  $P_{D(max)}$  is known, the maximum permissible value of  $R_{\theta JA}$  can be calculated:

$$R_{\Theta}JA = \frac{150^{\circ}C - T_{A}}{P_{D}}$$
 (2)

The value of  $R_{\theta JA}$  can then be compared with those in the package section of the data sheet. Those packages with  $R_{\theta JA}$ 's less than the calculated value in equation 2 will keep the die temperature below 150°C.

In some cases, none of the packages will be sufficient to dissipate the heat generated by the IC, and an external heatsink will be required.

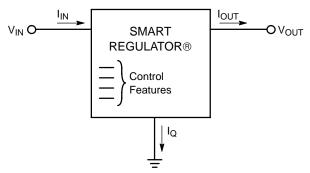


Figure 14. Single Output Regulator With Key Performance Parameters Labeled

### **Heat Sinks**

A heat sink effectively increases the surface area of the package to improve the flow of heat away from the IC and into the surrounding air.

Each material in the heat flow path between the IC and the outside environment will have a thermal resistance. Like series electrical resistances, these resistances are summed to determine the value of  $R_{\theta IA}$ .

$$R_{\Theta}JA = R_{\Theta}JC + R_{\Theta}CS + R_{\Theta}SA \tag{3}$$

where:

 $R_{\theta JC}$  = the junction-to-case thermal resistance,

 $R_{\theta CS}$  = the case-to-heatsink thermal resistance, and

 $R_{\theta SA}$  = the heatsink–to–ambient thermal resistance.

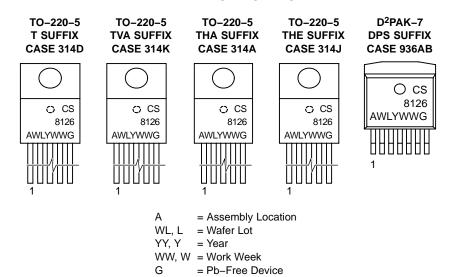
 $R_{\theta JC}$  appears in the package section of the data sheet. Like  $R_{\theta JA}$ , it is a function of package type.  $R_{\theta CS}$  and  $R_{\theta SA}$  are functions of the package type, heatsink and the interface between them. These values appear in heat sink data sheets of heat sink manufacturers.

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>	
CS8126-1YT5	TO-220-5 STRAIGHT	50 Units/Rail	
CS8126-1YT5G	TO-220-5 STRAIGHT (Pb-Free)	50 Units/Rail	
CS8126-1YTVA5	TO-220-5 VERTICAL	50 Units/Rail	
CS8126-1YTVA5G	TO-220-5 VERTICAL (Pb-Free)	50 Units/Rail	
CS8126-1YTHA5	TO-220-5 HORIZONTAL	50 Units/Rail	
CS8126-1YTHA5G	TO-220-5 HORIZONTAL (Pb-Free)	50 Units/Rail	
CS8126-1YTHE5	TO-220-5 SURFACE MOUNT	50 Units/Rail	
CS8126-1YTHE5G	TO-220-5 SURFACE MOUNT (Pb-Free)	50 Units/Rail	
CS8126-1YTHER5	TO-220-5 SURFACE MOUNT	750 / Tape & Reel	
CS8126-1YTHER5G	TO-220-5 SURFACE MOUNT (Pb-Free)	750 / Tape & Reel	
CS8126-1YDPS7	D <sup>2</sup> PAK-7	50 Units/Rail	
CS8126-1YDPS7G	D <sup>2</sup> PAK-7 (Pb-Free)	50 Units/Rail	
CS8126-1YDPSR7	D <sup>2</sup> PAK–7 750 / T		
CS8126-1YDPSR7G	D <sup>2</sup> PAK-7 (Pb-Free)	750 / Tape & Reel	

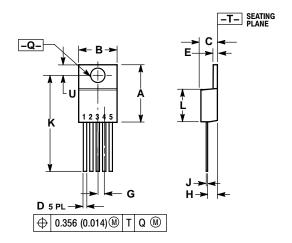
<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

#### **MARKING DIAGRAMS**



# **PACKAGE DIMENSIONS**

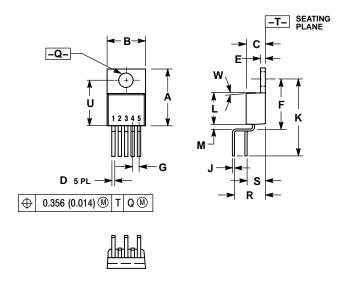
TO-220-5 T SUFFIX CASE 314D-04 ISSUE E



- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: INCH.
  3. DIMENSION D DOES NOT INCLUDE INTERCONNECT BAR (DAMBAR) PROTRUSION. DIMENSION D INCLUDING PROTRUSION SHALL NOT EXCEED 10.92 (0.043) MAXIMUM.

	INCHES		MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.572	0.613	14.529	15.570
В	0.390	0.415	9.906	10.541
С	0.170	0.180	4.318	4.572
D	0.025	0.038	0.635	0.965
E	0.048	0.055	1.219	1.397
G	0.067	BSC	1.702 BSC	
Н	0.087	0.112	2.210	2.845
J	0.015	0.025	0.381	0.635
K	0.990	1.045	25.146	26.543
L	0.320	0.365	8.128	9.271
Q	0.140	0.153	3.556	3.886
U	0.105	0.117	2.667	2.972

TO-220-5 **TVA SUFFIX** CASE 314K-01 ISSUE O



#### NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- Y14.5M, 1982.

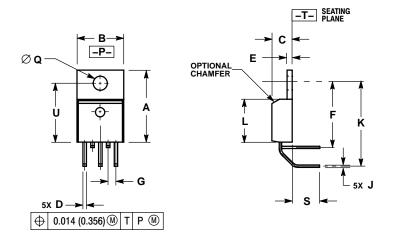
  2. CONTROLLING DIMENSION: INCH.

  3. DIMENSION D DOES NOT INCLUDE
  INTERCONNECT BAR (DAMBAR) PROTRUSION.
  DIMENSION D, INCLUDING PROTRUSION, SHALL
  NOT EXCEED 10.92 (0.043) MAXIMUM.

	INCHES		MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.560	0.590	14.22	14.99
В	0.385	0.415	9.78	10.54
C	0.160	0.190	4.06	4.83
D	0.027	0.037	0.69	0.94
Е	0.045	0.055	1.14	1.40
F	0.530	0.545	13.46	13.84
G	0.067 BSC		1.70 BSC	
J	0.014	0.022	0.36	0.56
K	0.785	0.800	19.94	20.32
L	0.321	0.337	8.15	8.56
M	0.063	0.078	1.60	1.98
Q	0.146	0.156	3.71	3.96
R	0.271	0.321	6.88	8.15
S	0.146	0.196	3.71	4.98
U	0.460	0.475	11.68	12.07
W	5	0	5°	

# **PACKAGE DIMENSIONS**

# TO-220-5 **THA SUFFIX** CASE 314A-03 ISSUE E



#### NOTES:

- IOTES:

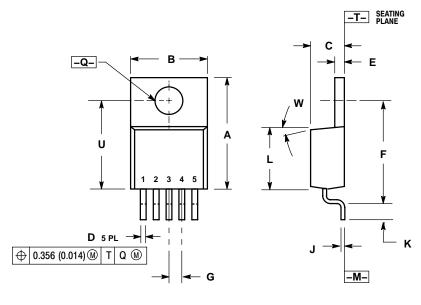
  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

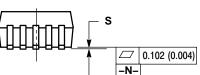
  2. CONTROLLING DIMENSION: INCH.

  3. DIMENSION DOES NOT INCLUDE INTERCONNECT BAR (DAMBAR) PROTRUSION. DIMENSION D INCLUDING PROTRUSION SHALL NOT EXCEED 0.043 (1.092) MAXIMUM.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
Α	0.572	0.613	14.529	15.570
В	0.390	0.415	9.906	10.541
C	0.170	0.180	4.318	4.572
D	0.025	0.038	0.635	0.965
Е	0.048	0.055	1.219	1.397
F	0.570	0.585	14.478	14.859
G	0.067	0.067 BSC		BSC
J	0.015	0.025	0.381	0.635
K	0.730	0.745	18.542	18.923
L	0.320	0.365	8.128	9.271
Q	0.140	0.153	3.556	3.886
S	0.210	0.260	5.334	6.604
U	0.468	0.505	11.888	12.827

### TO-220-5 **THE SUFFIX** CASE 314J-01 **ISSUE O**





#### NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI
- DTES:

  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

  2. CONTROLLING DIMENSION: INCH.

  3. DIMENSION D DOES NOT INCLUDE INTERCONNECT BAR (DAMBAR) PROTRUSION. DIMENSION D INCLUDING PROTRUSION SHALL NOT EXCEED 10.92 (0.043) MAXIMUM.

  4. DIMENSIONS EXCLUSIVE OF MOLD FLASH AND METAL BURRS.

  5. FOOTPAD LENGTH MEASURED FROM LEAD IT!P WITH REFERENCE TO DATUM -M.

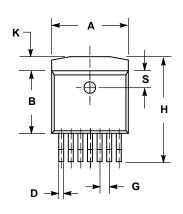
  6. COPLANARITY 0.004" MAX. REFERENCE TO DATUM -N.—STANDOFF HEIGHT 0.00 0.010".

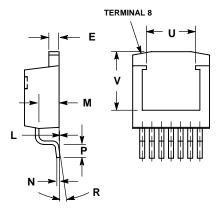
	INC	UEC	MILLIMETERS	
	INCHES		WILLIN	EIENS
DIM	MIN	MAX	MIN	MAX
Α	0.568	0.583	14.43	14.81
В	0.395	0.405	10.03	10.29
С	0.170	0.180	4.32	4.57
D	0.028	0.036	0.71	0.91
Е	0.045	0.055	1.14	1.40
F	0.543	0.558	13.79	14.17
G	0.06	7 BSC	1.70 BSC	
J	0.014	0.022	0.36	0.56
K	0.073	0.088	1.85	2.24
٦	0.324	0.339	8.23	8.61
Q	0.146	0.156	3.71	3.96
S	0.000	0.010	0.00	0.25
U	0.460	0.475	11.68	12.07
W	5 °		5	0

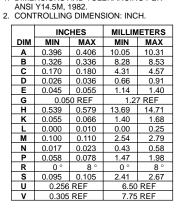
#### PACKAGE DIMENSIONS

## D<sup>2</sup>PAK-7 (SHORT LEAD) DPS SUFFIX

CASE 936AB-01 ISSUE A

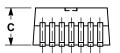




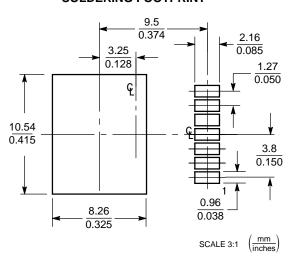


DIMENSIONS AND TOLERANCING PER

NOTES



#### **SOLDERING FOOTPRINT\***



\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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